

€) کاٹ**لا**ٹ AEC-Q Compliant

Typical Part Marking

Fuse body (ceramic white side) marked with marking code.

Example:



Current Rating	Marking Code	Current Rating	Marking Code
500mA	J	3A	3
750mA	М	3.5A	Z
1A	1	4A	4
1.25A	Р	5A	5
1.5A	R	6A	6
2A	2	7A	7
2.5A	Т	8A	8

Type C2F Surface Mount Fast Acting Chip Fuse

HF 66 C2F Series – 0603 Size

RoHS 2 Compliant

Features

- Fast Acting, with improved surge withstand performance
- Small size, 0603 SMD
- Current rating from 500mA to 8A, fuse marked with ampere code
- Wide operating temperature range from -55°C to 125°C
- Tape and Reel for automatic SMD placement
- Compatible with 260°C IR Pb-free and wave soldering process
- AEC-Q Compliant
- RoHS 2 compliant (MSL = 1)
- Halogen Free
- Lead Free
- Meets Bel automotive qualification*
- * Largely based on internal AEC-Q test plan

Applications

- Notebook
- Automotive Navigation System
- LED Lighting
- Thin film transistor LCD flat-panel display screen
- PC computer
- Office electronic equipment
- Industrial equipment
- Medical equipment
- POE, POE+
- LCD / LED monitor and LCD / LED TV
- Power supply

- DC-DC Converter

LEAD FREE =

HALOGEN FREE = HF



Electrical Characteristics (UL STD. 248-14)

T :: 0 :	Blow Time		
Testing Current	Minimum	Maximum	
100%	4 Hrs.	N/A	
200%	N/A	5 Sec	
300%	N/A	0.2 Sec	

Safety Agency Approvals

Safety Agency	Safety Agency Certificate	Voltage Rating (V)	Ampere Range / Volt @ I.R. ability*		
c FL °us	E20624	500mA-8A/32V AC /63V DC	500mA-8A/35A@ 32V AC		
/63V DC /50A@ 63V DC *I.R.= Interrupting Rating = Short Circuit Rating(Amps)					

Physical Specifications

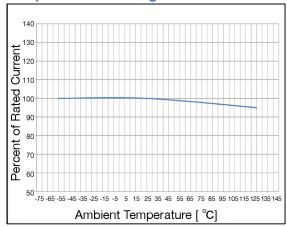
- 1	ny oroan	opositioationio
		Body : Ceramic Substrate
	Materials	Terminations : Ag / Ni / Sn (100% Lead-free)
		Element Cover Coating : Lead-free Glass
		On Fuse :
		Marking Code
	Marking	On Label :
	Iviaiking	"bel", "C2F", "Current Rating", "Voltage Rating", "Interrupting Rating",
		"Appropriate Safety Logos" and " , " ", " (China RoHS compliant).



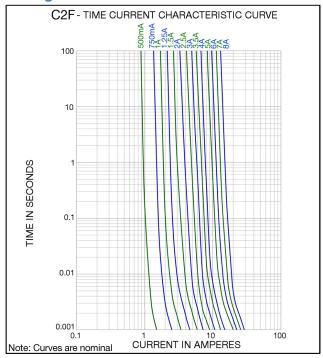
Specifications subject to change without notice

Type C2F

Temperature Derating Curve



Average Time Current Curve



Electrical Specifications

Part Number	Ampere Rating (A)	Marking Code	Nominal Cold Resistance	Maximum Volt-drop @100% In	Voltage and Interrupting Ratings	Nominal Melting I ² T @10 In	Maximum Power Dissipation @100% In	Agency Approvals
	(٨)		(ohms)	(Volt) max.	Raings	(A² Sec)	(W)	c 71 2° us
0686F0500-XX	500mA	J	0.430	0.310		0.0003	0.16	Υ
0686F0750-XX	750mA	М	0.225	0.230		0.0013	0.17	Υ
0686F1000-XX	1A	1	0.150	0.215		0.0028	0.22	Υ
0686F1250-XX	1.25A	Р	0.110	0.195	See Table	0.0045	0.24	Υ
0686F1500-XX	1.5A	R	0.088	0.185	of Safety	0.008	0.28	Υ
0686F2000-XX	2A	2	0.060	0.180	Approvals	0.014	0.36	Υ
0686F2500-XX	2.5A	Т	0.035	0.115	on Page 1	0.027	0.29	Υ
0686F3000-XX	3A	3	0.026	0.110	for Voltage and	0.040	0.33	Υ
0686F3500-XX	3.5A	Z	0.021	0.103	associated	0.058	0.36	Υ
0686F4000-XX	4A	4	0.017	0.100	Interrupting	0.110	0.40	Υ
0686F5000-XX	5A	5	0.0135	0.098	Ratings	0.140	0.49	Υ
0686F6000-XX	6A	6	0.0113	0.106		0.210	0.64	Υ
0686F7000-XX	7A	7	0.0092	0.107		0.350	0.75	Υ
0686F8000-XX	8A	8	0.0075	0.097		0.500	0.78	Υ

Consult manufacturer for other ratings

NOTES: Test Conditions

All test for ratings 500mA - 5A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.035 mm (35µm) nominal thickness (1 oz.clad), 5mm wide and 100 mm overall length.

All test for ratings 6A-8A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.070 mm (70µm) nominal thickness (2 oz. clad), 7.5mm wide and 100 mm overall length.

Device designed to be mounted with marking facing up.

Device designed to carry rated current for 4 hours minimum. It is recommended that device be operated continuously at no more than 80% of rated current when in a +25°C ambient, with further derating at elevated ambient temperatures.



Specifications subject to change without notice

Bel Fuse Inc. 206 Van Vorst Street Jersey City, NJ 07302 USA +1 201.432.0463 Bel.US.CS@belf.com belfuse.com/circuit-protection Type C2F

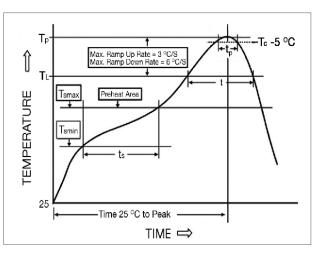
Environmental Specifications

Shock Resistance	MIL-STD-202G, Method 213B, Test Condition 1 (100 G's peak for 6 milliseconds; Sawtooth waveform)		
Vibration Resistance	MIL-STD-202G, Method 201A (10-55 Hz,0.06 inch, total excursion).		
Salt Spray Resistance	MIL-STD-202G, Method 101E, Test Condition B (48 hrs).		
Insulation Resistance	MIL-STD-202G, Method 302, Test Condition A (After Opening) 10,000 ohms minimum.		
Solderability	MIL-STD-202G, Method 208H		
Resistance to solder Heat	MIL-STD-202G, Method 210F, Test Condition C. Top Side(260°C,20 sec) MIL-STD-202G, Method 210F, Test Condition D. Bottom Side(260°C,10 sec)		
Thermal Shock	MIL-STD-202G, Method 107G, Test Condition B (-65 $^{\circ}$ C to +125 $^{\circ}$ C).		
Operating Temperature	-55℃ to +125℃		
Moisture Sensitivity Level	1 (According to IPC J-Std-020)		

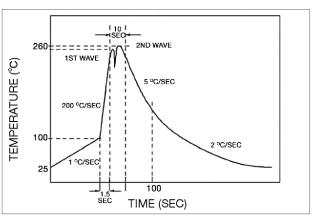
High temperature storage	MIL-STD-202 Method 108
Temperature cycling	JESD22 Method JA-104,Test Condition B
Biased humidity	MIL-STD-202 Method 103,85C/85% RH with 10% operating power for 1000 hrs
Operational life	MIL-STD-202 Method 108, Test Condition D
Resistance to solvents	MIL-STD-202 Method 215
Mechanical shock	MIL-STD-202 Method 213,Test Condition C
Vibration	MIL-STD-202 Method 204
Resistance to soldering heat	MIL-STD-202 Method 210,Test condition B
Thermal shock	MIL-STD-202 Method 107
Solderability	J-STD-002
Board flex(SMD)	AEC-Q200-005
Terminal strength	AEC-Q200-006
Electrical characterization	3 temperature electrical

Soldering Parameters

IR Reflow Profile (IPC/JEDEC J-STD-020D)				
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-120 seconds			
Average ramp-up rate (Tsmax to Tp)	3°C/second max.			
Liquidous temperature (TL) Time at liquidous (tL)	217℃ 60-150 seconds			
Peak temperature (Tp)	260°C max			
Time (tp) within 5°C of the specified classification temperture (Tc)	30 seconds			
Average ramp-down rate (Tp to Tsmax)	6℃/second max.			
Time 25℃ to peak temperature	8 minutes max.			



Lead-free Wave Soldering Profile				
Wave Soldering Parameter				
Average ramp-up rate	200°C / second			
Heating rate during preheat	typical 1 - 2°C / second Max 4°C / second			
Final preheat temperature	within 125℃ of soldering temperature			
Peak temperature Tp	260℃			
Time within +0°C / -5°C of actual peak temperature	10 seconds			
Ramp-down rate	5°C / second max.			





Specifications subject to change without notice

Bel Fuse Inc. 206 Van Vorst Street Jersey City, NJ 07302 USA +1 201.432.0463 Bel.US.CS@belf.com belfuse.com/circuit-protection Type C2F

Fuse FGNO Explanation 0686 F [XXXX] X XX

0686F=C2F; [XXXX]=Ampere Rating; XX=See Ordering Information as below

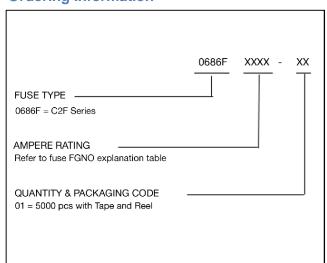
Fraction	Decimal	Milliamps	Bel FGNO[XXXX]
1/2	0.500	500	0500
3/4	.750	750	0750

Fraction	Decimal	Amps	Bel FGNO[XXXX]
	1.0	1	1000
1-1/4	1.25	1.25	1250
1-1/2	1.50	1.5	1500
	2.0	2	2000
2-1/2	2.5	2.5	2500
	3.0	3	3000
3-1/2	3.5	3.5	3500
	4.0	4	4000
	5.0	5	5000
	6.0	6	6000
	7.0	7	7000
	8.0	8	8000

Mechanical Dimensions

BOTTOM TOP 0.35mm±0.15mm (0.014"±0.006") MARKING CODE 0.82mm±0.15mm (0.032"±0.006") 1.60mm±0.15mm (0.063"±0.006") 0.52mm±0.08mm (0.020"±0.003") RECOMMENDED PAD LAYOUT C2F 0.76mm (0.030'') 0.76mm (0.030'') 1.09mm (0.043'') 1.27mm (0.05'') d 0.76mm (0.030'') -| 0.91mm (0.036'') INFRARED REFLOW WAVE SOLDER

Ordering Information



Packaging

Packaging Tape & Reel	Packaging Specification	Quantity	Quantity & Packaging Code
8 mm wide tape with 7 inches Diameter reel	EIA Standard 481-E	5000	0686FXXXX-01



Specifications subject to change without notice

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Bel:

<u>0686F5000-01</u> <u>0686F1500-01</u> <u>0686F2500-01</u> <u>0686F8000-01</u> <u>0686F6000-01</u> <u>0686F2000-01</u> <u>0686F1250-01</u> 0686F0500-01 0686F3500-01 0686F1000-01 0686F3000-01 0686F0750-01 0686F4000-01 0686F7000-01